APPLICA	BLE STAND	ARD										
OPERATING TEMPERATURE RA		RANGE	-55°C TO +105°C ⚠	TEMF	STORAGE FEMPERATURE RANGE DPERATING OR STORAGE HUMIDITY RANGE		-10°C TO +50°C(PACKED CONDITION)					
RATING	VOLTAGE		30V AC/DC	l l			GE RE	RELATIVE HUMIDITY 90%MAX(NOT				
	CURRENT		0.2A APPLICABLE C		cable t=0.2±0.03mm, GOLD PLA			0.03mm, GOLD PLATED				
			SPEC	IFICA	1OIT	NS						
Γ	ТЕМ		TEST METHOD					REQU	IREMENTS	QT	АТ	
CONSTR		1				I				1	1	
GENERAL EX	KAMINATION	VISUALL	SUALLY AND BY MEASURING INSTRUMENT.			ACCORDING TO DRAWING.				×	×	
MARKING		CONFIRM	CONFIRMED VISUALLY.							×	×	
	CAL CHAR	ACTERI	STICS									
VOLTAGE P	ROOF	90V AC F	FOR 1 min.			NO FLAS	SHOVEF	RORE	BREAKDOWN.	×	×	
INSULATION	INSULATION RESISTANCE		100V DC.			50MΩ MIN.				×	×	
CONTACT RESISTANCE		AC 20mV	C 20mV MAX (1KHz), 1mA.			100m Ω MAX. INCLUDING FPC BULK RESISTANCE (L=12mm)				×	×	
MECHAN	ICAL CHAI	RACTER	ISTICS							ı	1	
VIBRATION			FREQUENCY 10 TO 55 Hz, HALF AMPLITUDE				① NO ELECTRICAL DISCONTINUITY OF 1 μ s.				_	
SHOCK			0.75 mm FOR 10 CYCLES IN 3 AXIAL DIRECTIONS. 981 m/s ² . DURATION OF PULSE 6ms AT 3 TIMES			② CONTACT RESISTANCE: 100mΩ MAX. ③ NO DAMAGE, CRACK AND LOOSENESS				×		
		IN 3 BOT	IN 3 BOTH AXIAL DIRECTIONS.			OF PARTS.			×	_		
MECHANICA	MECHANICAL OPERATION		10 TIMES INSERTIONS AND EXTRACTIONS.			① CONTACT RESISTANCE: 100mΩ MAX. ② NO DAMAGE, CRACK AND LOOSENESS OF PARTS.			×	_		
FPC RETENTION FORCE		MEASURED BY APPLICABLE FPC. (THICKNESS OF FPC SHALL BE t=0.20mm AT INITIAL CONDITION.)			DIRECTION OF INSERTION: 0.2N × NUMBER OF CONTACTS MIN. (note1)			×	_			
ENVIRON	IMENTAL (1	TERISTICS			(110001)				ı	1	
CORROSION SALT MIST		EXPOSED AT 35±2°C, 5% SALT WATER SPRAY			1	_			ANCE: 100m Ω MAX.	×	_	
		FOR 96h.				_	AMAGE ARTS.	E, CRA	CK AND LOOSENESS			
						_			CORROSION WHICH RATION OF CONNECTOR			
RAPID CHANGE OF TEMPERATURE		TEMPERATURE $-55 \rightarrow +15$ TO $+35 \rightarrow +85 \rightarrow +15$ TO $+35$ °C TIME $30 \rightarrow 2$ TO $3 \rightarrow 30 \rightarrow 2$ TO 3 min UNDER 5 CYCLES.				CONTACT RESISTANCE: 100m Ω MAX. INSULATION RESISTANCE: 50M Ω MIN. NO DAMAGE, CRACK AND LOOSENESS OF PARTS.				×	_	
DAMP HEAT	DAMP HEAT		EXPOSED AT 40±2°C,									
			RELATIVE HUMIDITY 90 TO 95%, 96h. EXPOSED AT -10 TO +65 °C			① CONTACT RESISTANCE: 100mΩ MAX.				×	_	
DAMP HEAT	DAMP HEAT, CYCLIC		RELATIVE HUMIDITY 90 TO 96 % 10 CYCLES, TOTAL 240h.			② INSULATION RESISTANCE: 1MΩ MIN. (AT HIGH HUMIDITY) ③ INSULATION RESISTANCE: 50MΩ MIN. (AT DRY) ④ NO DAMAGE, CRACK AND LOOSENESS				×	_	
						_	ARTS.	L, OIV	TON AND LOCULINEOU			
COUN	Т	DESCRIPTI	ON OF REVISIONS		DESIGNED		NED		CHECKED	DATE		
1		DIS-F-00000511 YH.N			YH.MIC	ICHIDA			YN.TAKASHITA	15.0	15.07.29	
REMARK							APPRO	VED	MO.ISHIDA	14.0	1.24	
							CHECK		HS.SAKAMOTO		1.24	
Unless otherwise specifie			ied, refer to IEC 60512			DESIGNE			YS.EBI		1.24	
Note QT:Qualification Test AT:Assurance Test X:A				DRAWING					NM.SANPEI ELC4-338903	14.01.21 03-05		
	T							5C-**S-0.3SHW(
HS		IROSE ELECTRIC CO., LTD.			CODE NO.		CL580				1/2	

	SPECIFICATIO	NS		
ITEM	TEST METHOD	REQUIREMENTS	QT	АТ
DRY HEAT	EXPOSED AT 85±2°C, 96h.	 CONTACT RESISTANCE: 100m Ω MAX. NO DAMAGE, CRACK AND LOOSENESS OF PARTS. 	×	_
COLD	EXPOSED AT -55±3°C, 96h.		×	_
SULPHUR DIOXIDE [JIS C 60068-2-42]	EXPOSED AT 40±2°C, RELATIVE HUMIDITY 80±5 %, 25±5 ppm FOR 96h.	 CONTACT RESISTANCE: 100mΩ MAX. NO DAMAGE, CRACK AND LOOSENESS OF PARTS. 	×	_
HYDROGEN SULPHIDE [JIS C 60068-2-43]	EXPOSED AT 40±2°C, RELATIVE HUMIDITY 80±5 %, 10 TO 15 ppm FOR 96h.	③ NO EVIDENCE OF CORROSION WHICH AFFECTS TO OPERATION OF CONNECTOR.	×	_
SOLDERABILITY	SOLDERED AT SOLDER TEMPERATURE, 235±5°C FOR IMMERSION DURATION, 2±0.5 sec.	A NEW UNIFORM COATING OF SOLDER SHALL COVER A MINIMUM OF 95 % OF THE SURFACE BEING IMMERSED.	×	_
RESISTANCE TO SOLDERING HEAT	1) REFLOW SOLDERING: PEAK TMP. 250°CMAX. REFLOW TMP. 230°C MIN WITHIN 60 sec. 2) SOLDERING IRONS:	NO DEFORMATION OF CASE OF EXCESSIVE LOOSENESS OF THE TERMINALS.	×	_
	TMP. 350±10°C FOR 5±1 sec.			

(note1)

FASTEN FPC ON PCB OR SOMETHING FIXED IF FORCE IN VERTICAL DIRECTION SHALL BE PREDICTED. DO NOT CLOSE THE ACTUATOR BEFORE INSERTING FPC EVEN AFTER THE CONNECTOR IS MOUNTED ONTO A PCB. CLOSING THE ACTUATOR WITHOUT FPC COULD MAKE THE CONTACT GAP SMALLER, WHICH INCREASES THE FPC INSERTION FORCE.

THIS CONNECTOR HAS CONTACT POINTS ON BOTH TOP AND BOTTOM.

Note QT:Qua	alification Test AT:Assurance Test X:Applicable Test	DRAWIN	G NO.	ELC4-338903-05		
HRS	SPECIFICATION SHEET	PART NO.	o. FH35C-**S-0.3SHW(99)			
πО	HIROSE ELECTRIC CO., LTD.	CODE NO.		CL580	\triangle	2/2